

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX244F, TC74LCX244FK

Low-Voltage Octal Bus Buffer with 5-V Tolerant Inputs and Outputs

The TC74LCX244 is a high-performance CMOS octal bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

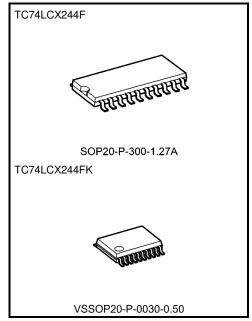
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

The TC74LCX244 is a non-inverting 3-state buffer having two active-low output enables. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation: $t_{pd} = 6.5 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min) (V}_{CC} = 3.0 \text{ V)}$
- Available in JEITA SOP, VSSOP (US)
- · Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 244 type



Weight

SOP20-P-300-1.27A : 0.22 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

Note: The Electrical Characteristics of V_{CC} = 1.8 \pm 0.15 V is only applicable for products which manufactured from January 2009 onward.

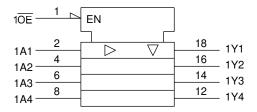
Start of commercial production 1994-03

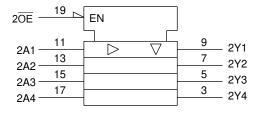


Pin Assignment (top view)

1OE 20 V_{CC} 1A1 19 2OE 18 1Y1 2Y4 3 1A2 2A4 2Y3 5 1Y2 1A3 6 15 2A3 2Y2 7 1Y3 1A4 2A2 8 2Y1 1Y4 9 12 GND 10 2A1

IEC Logic Symbol





Truth Table

Inputs		Outouto
ŌĒ	An	Outputs
L	L	L
L	Н	Н
Н	Х	Z

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vcc	-0.5 to 7.0	V
DC input voltage	VIN	–0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	Vout	-0.5 to V _{CC} + 0.5 (Note 3)	V
Input diode current	lıĸ	-50	mA
Output diode current	Іок	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC Vcc/ground current	ICC/IGND	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: VOUT < GND, VOUT > VCC

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Power aupply voltage	Vcc	1.65 to 3.6	V	
Power supply voltage	VCC	1.5 to 3.6 (Note 2)	V	
Input voltage	V _{IN}	0 to 5.5	V	
Output voltage	\/a	0 to 5.5 (Note 3)	٧	
Output voltage	Vout	0 to V _{CC} (Note 4)		
Output ourrent	la/la.	±24 (Note 5)	mA	
Output current	IOH/IOL	±12 (Note 6)	IIIA	
Operating temperature	T _{opr}	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5: VCC = 3.0 to 3.6 V

Note 6: VCC = 2.7 to 3.0 V

Note 7: VIN = 0.8 to 2.0 V, VCC = 3.0 V



Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteristics		Symbol	nol Test Condition			Min	Max	Unit	
Characterist	iics	Syllibol	Test Col	Vo		IVIII I	IVIAX	Offic	
					1.65 to 2.3	Vcc×0.9	_		
	H-level	VIH	_		2.3 to 2.7	1.7	_		
Laurent contra a c					2.7 to 3.6	2.0	_	٧	
Input voltage					1.65 to 2.3	_	Vcc×0.1		
	L-level	VIL	_	-	2.3 to 2.7	_	0.7		
					2.7 to 3.6	_	0.8		
				ΙΟΗ = -100 μΑ	1.65 to 3.6	Vcc-0.2	_		
				I _{OH} = -4 mA	1.65	1.05	_		
	H-level	Maria	Maria Maria Ma	IOH = -8 mA	2.3	1.7		V	
	H-level	Voн	$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -12 mA	2.7	2.2			
				IOH = -18 mA	3.0	2.4	_		
Outrout well-				I _{OH} = -24 mA	3.0	2.2			
Output voltage			VIN = VIH or VIL	I _{OL} = 100 μA	1.65 to 3.6	_	0.2		
				I _{OL} = 4 mA	1.65	_	0.45		
				I _{OL} = 8 mA	2.3		0.7		
	L-level	V _{OL}		I _{OL} = 12 mA	2.7		0.4		
					I _{OL} = 16 mA	3.0	_	0.4	
				I _{OL} = 24 mA	3.0		0.55		
Input leakage current		I _{IN}	V _{IN} = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μА	
3-state output off-state current IO		loz	V _{IN} = V _{IH} or V _{IL} V _{OUT} = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μА	
Power off leakage cur	rent	IOFF	VIN/VOUT = 5.5 V		0	_	10.0	μΑ	
		Icc	V _{IN} = V _{CC} or GND		1.65 to 3.6	_	10.0		
Quiescent supply curr	Quiescent supply current		V _{IN} /V _{OUT} = 3.6 to 5.5 V		1.65 to 3.6	_	±10.0	μΑ	
Increase in ICC per inp	out	Δlcc	VIH = VCC - 0.6V ((per 1 input)	2.7 to 3.6		500		



AC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Characteristics Symbol Test Condition		Min	Max	Unit	
Characterionics	Cymbol	rest definition	V _{CC} (V)	IVIIII	IVIAX	Offic
			1.8 ± 0.15		25.0	
Dranagation dalay time	tpLH	Figure 1 Figure 2	2.5 ± 0.2		8.5	
Propagation delay time	tpHL	Figure 1, Figure 2	2.7	_	7.5	ns
			3.3 ± 0.3	1.5	6.5	
	t _{pZL} Fiq	Figure 1, Figure 3	1.8 ± 0.15		32.0	ns
Outrout analyla time			2.5 ± 0.2		16.0	
Output enable time			2.7		9.0	
			3.3 ± 0.3	1.5	8.0	
			1.8 ± 0.15		30.0	
Outside disable the	t _{pLZ} t _{pHZ}	Figure 1, Figure 3	2.5 ± 0.2		15.0	
Output disable time			2.7	_	8.0	ns
			3.3 ± 0.3	1.5	7.0	
Output to output skow	tosLH	A.	2.7	_	_	
Output to output skew tosHL	(Note)	3.3 ± 0.3		1.0	ns	

Note: Parameter guaranteed by design.

(tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|)

Dynamic Switching Characteristics (Ta = 25°C, input: tr = tf = 2.5 ns, CL = 50 pF, RL = 500 Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	٧
Quiet output minimum dynamic VOL	Volv	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	CIN	_	3.3	7	pF
Output capacitance	Соит	_	3.3	8	pF
Power dissipation capacitance	CPD	f _{IN} = 10 MHz (No	te) 3.3	25	pF

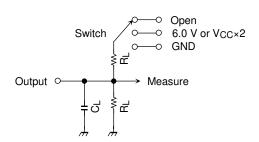
Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current

Average operating current can be obtained by the equation:

ICC (opr) = CPD \cdot VCC \cdot fIN + ICC/8 (per bit)



AC Test Circuit



Parameter	Switch		
t _{pLH} , t _{pHL}	Open		
* 1 7 * 7	6.0 V @ V _{CC} = 3.3 ± 0.3 V @ V _{CC} = 2.7 V		
tpLZ, tpZL	V _{CC} × 2 @ V _{CC} = 2.5 ± 0.2 V @ V _{CC} = 1.8 ± 0.15 V		
t _{pHZ} , t _{pZH}	GND		

Figure 1



AC Waveform

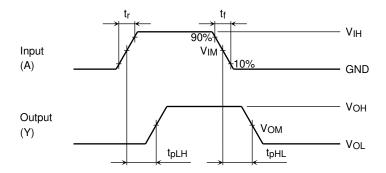


Figure 2 t_{pLH}, t_{pHL}

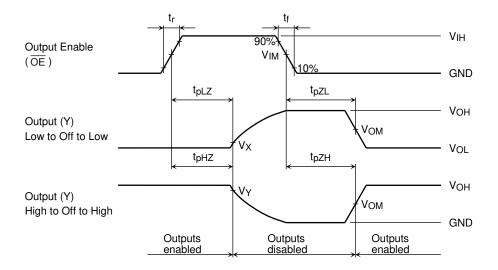


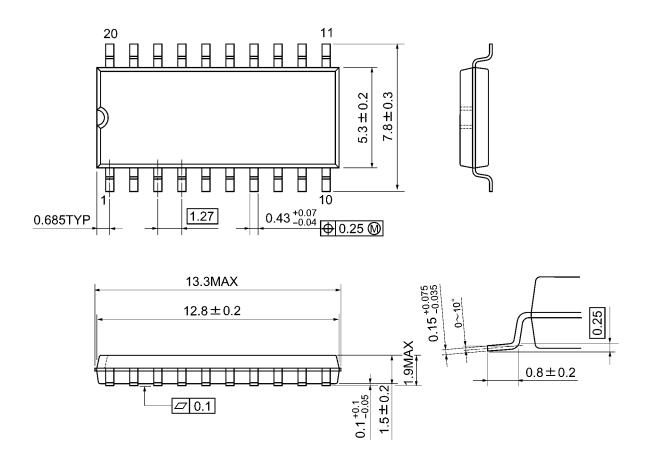
Figure 3 t_{pLZ} , t_{pHZ} , t_{pZL} , t_{pZH}

			Vcc	
	Symbol	$3.3 \pm 0.3 \text{ V}$ 2.7 V	2.5 ± 0.2 V	1.8 ± 0.15 V
Input	V _{IH}	2.7 V	V _{CC}	V _{CC}
	VIM	1.5 V	V _{CC} /2	V _{CC} /2
	t _r , t _f	2.5 ns	2.0 ns	2.0 ns
Output	V _{OM}	1.5 V	V _{OH} /2	V _{OH} /2
	VX	V _{OL} +0.3 V	V _{OL} +0.15 V	V _{OL} +0.15 V
	VY	V _{OH} -0.3 V	V _{OH} -0.15 V	V _{OH} -0.15 V
Load	CL	50 pF	30 pF	30 pF
	RL	500 Ω	500 Ω	1 kΩ



Package Dimensions

SOP20-P-300-1.27A Unit: mm

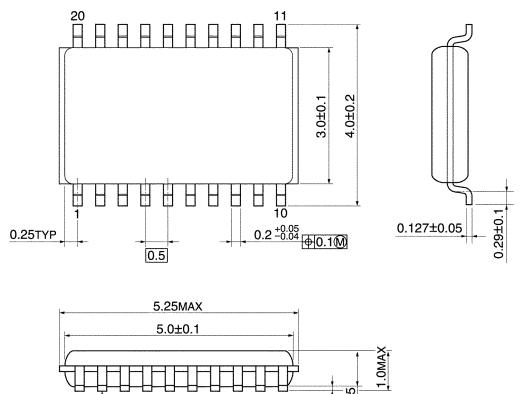


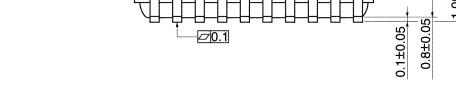
Weight: 0.22 g (typ.)



Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm





Weight: 0.03 g (typ.)



RESTRICTIONS ON PRODUCT USE

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
 EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY
 CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
 ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation,
 equipment used in nuclear facilities, equipment used in the aerospace industry, lifesaving and/or life supporting medical equipment,
 equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or
 explosions, safety devices, elevators and escalators, and devices related to power plant. IF YOU USE PRODUCT FOR UNINTENDED USE,
 TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your TOSHIBA sales representative or contact us via our
 website.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
 applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR
 PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER,
 INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING
 WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2)
 DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR
 INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE,
 ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please
 use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including
 without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT
 OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

TOSHIBA ELECTRONIC DEVICES & STORAGE CORPORATION

https://toshiba.semicon-storage.com/